PCN Number:	<b>Number:</b> 20240321000.2						PCN Date:		March 21, 2024		
Title: Adding CD-PR as additional wafer probe (EWS) site											
Customer Contact:Change Management teamDept:						Quality Services					
Proposed 1 <sup>st</sup> Sh	September 17, 2024			Sample Requests Samples not accepted until: supported							
Change Type:											
Assembly Sit	Design					Wafer Bump Material					
Assembly Pro	ocess	Data She					Wafer Bump Process				
Assembly Ma	iterials				nber change			Wafer Fab Site			
Mechanical S							Wafer Fab Material				
Packing/Ship	ping/Labe	ling Test Process				Wafer Fab Proces			Process		
PCN Details											
Description of Change:											
Texas Instruments Incorporated has qualified CD-PR as additional probe (EWS) site for the devices listed below to support high volume ramps.											
Current: New:											
Probe Site (EWS) TI CLARK (CLARK-PR) TI CHENGDU (CD-PR)											
Test coverage, insertions, conditions will remain consistent with current testing.											
Reason for Change:											
Enable additional probe capacity to support high volume ramps.											
Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):											
None											
Impact on Environmental Ratings											
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.RoHSREACHGreen StatusIEC 62474											
		-							1		
No Change		No Chan			No Change			No Ch	lange		
Changes to product identification resulting from this PCN:											
None											
Product Affected:											
AWR2943ABGALT		R2944ABGA	LTQ1	AWR2	944BGALT	Q1	AW	/R2F44	ABGALLRQ1		
AWR2943ABGALTI	-	AWR2944ABGALTRQ		AWR2944BGALTRQ1					ABSALLRQ1		
AWR2943ABSALT		AWR2944ABSALTQ1		AWR2944BSALTQ1				AWR2G44ABGALLRQ1			
AWR2943ABSALT			-			2944BSALTRQ1			AWR2G44ABSALLRQ1		
						-					

## ZVEI ID reference: SEM-TF-01

For questions regarding this notice, e-mails can be sent to Change Management team or your local Field Sales Representative.

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